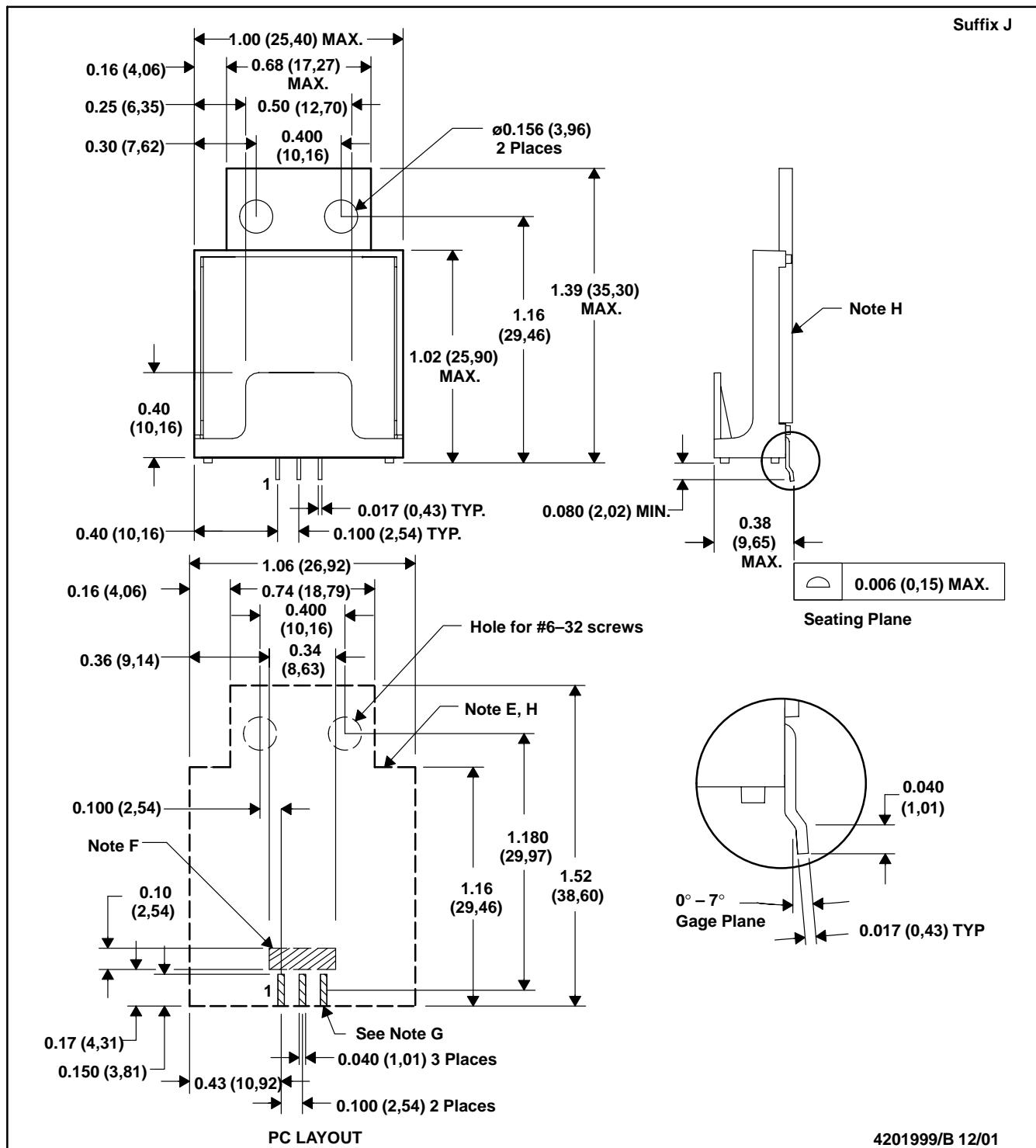


EAJ (R-PSIP-G3)

PLASTIC SINGLE-IN-LINE MODULE



NOTES:

- A. All linear dimensions are in inches (mm).
- B. This drawing is subject to change without notice.
- C. 2-place decimals are ± 0.030 (± 0.76 mm).
- D. 3-place decimals are ± 0.010 (± 0.25 mm).
- E. Recommended mechanical keep-out area.
- F. No copper, power or signal traces in this area.

- G. Power pin connections should utilize two or more vias per input, ground and output pin.
- H. The metal tab is isolated but electrically conductive. No signal traces are allowed under the metal tab area. A solid copper island is recommended, which may be grounded.



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